

# PRODUCT / PROCESS CHANGE NOTIFICATION

## 1. PCN basic data

|                      |                                                                                                                        |
|----------------------|------------------------------------------------------------------------------------------------------------------------|
| 1.1 Company          |  STMicroelectronics International N.V |
| 1.2 PCN No.          | MICROCONTROLLERS/25/15321                                                                                              |
| 1.3 Title of PCN     | ST25R100 & ST25R200 NFC Reader IC transfer to JSCC                                                                     |
| 1.4 Product Category | ST25R100-CMET<br>ST25R200-BMET                                                                                         |
| 1.5 Issue date       | 2025-04-16                                                                                                             |

## 2. PCN Team

|                           |                          |
|---------------------------|--------------------------|
| 2.1 Contact supplier      |                          |
| 2.1.1 Name                | ROBERTSON HEATHER        |
| 2.1.2 Phone               | +1 8475853058            |
| 2.1.3 Email               | heather.robertson@st.com |
| 2.2 Change responsibility |                          |
| 2.2.1 Product Manager     | David RICETTO            |
| 2.1.2 Marketing Manager   | Sylvain FIDELIS          |
| 2.1.3 Quality Manager     | Mickael DENAIS-ALLICHON  |

## 3. Change

|              |                                                                                                                                                 |                            |
|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|
| 3.1 Category | 3.2 Type of change                                                                                                                              | 3.3 Manufacturing Location |
| Transfer     | Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617) | N/A                        |

## 4. Description of change

|                                                                                       |                                                                                                                                                                                     |                                                                                                    |
|---------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------|
|                                                                                       | Old                                                                                                                                                                                 | New                                                                                                |
| 4.1 Description                                                                       | The ST25R100 & ST25R200 currently assembled & tested at UTAC (Thailand) UTL1...                                                                                                     | ...will be transferred to JSCC new qualified assembly & test site (STATS ChipPAC Jiangyin, China). |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | - Form: Marking change:<br>Second line of marking passing from blank to GQ (Assembly Country & plant) for new product at JSCC.<br><br>- Fit: No change<br><br>- Function: No change |                                                                                                    |

## 5. Reason / motivation for change

|                      |                                                                                                                                                                                                                                                            |
|----------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 5.1 Motivation       | The strategy of the STMicroelectronics CS division is to support our customers on product and service quality on a long-term basis. In line with this commitment, the new assembly & test site JSCC will allow better lead times and increase of capacity. |
| 5.2 Customer Benefit | CAPACITY INCREASE                                                                                                                                                                                                                                          |

## 6. Marking of parts / traceability of change

|                 |        |
|-----------------|--------|
| 6.1 Description | New FG |
|-----------------|--------|

## 7. Timing / schedule

|                                     |              |
|-------------------------------------|--------------|
| 7.1 Date of qualification results   | 2025-04-01   |
| 7.2 Intended start of delivery      | 2025-04-10   |
| 7.3 Qualification sample available? | Upon Request |

## 8. Qualification / Validation

|                                                    |                            |            |            |
|----------------------------------------------------|----------------------------|------------|------------|
| 8.1 Description                                    | 15321 RRCS2401.pdf         |            |            |
| 8.2 Qualification report and qualification results | Available (see attachment) | Issue Date | 2025-04-16 |

| 9. Attachments (additional documentations)                                            |                         |                          |
|---------------------------------------------------------------------------------------|-------------------------|--------------------------|
| 15321 Public product.pdf<br>15321 PCN ST25R200 UTL1 to JSCC.pdf<br>15321 RRCS2401.pdf |                         |                          |
| 10. Affected parts                                                                    |                         |                          |
| 10. 1 Current                                                                         |                         | 10.2 New (if applicable) |
| 10.1.1 Customer Part No                                                               | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No  |
|                                                                                       | ST25R100-CMET           |                          |
|                                                                                       | ST25R200-BMET           |                          |

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